# **MMVL3102T1**

Preferred Device

# **Silicon Tuning Diode**

This device is designed in the Surface Mount package for general frequency control and tuning applications. It provides solid–state reliability in replacement of mechanical tuning methods.

#### **Features**

- High Q with Guaranteed Minimum Values at VHF Frequencies
- Controlled and Uniform Tuning Ratio
- Pb-Free Package is Available

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Continuous Reverse Voltage	V <sub>R</sub>	30	Vdc
Peak Forward Current	IF	200	mAdc

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR–5 Board, T <sub>A</sub> = 25°C (Note 1) Derate above 25°C	P <sub>D</sub>	200 1.57	mW mW/°C
Thermal Resistance Junction-to-Ambient	$R_{\theta JA}$	635	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. FR-4 Minimum Pad



# ON Semiconductor®

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# 22 pF (Nominal) 30 VOLTS VOLTAGE VARIABLE CAPACITANCE DIODE





PLASTIC SOD-323 CASE 477 STYLE 1

## **MARKING DIAGRAM**



4C = Device Code M = Date Code\*

= Pb–Free Package

(Note: Microdot may be in either location)
\*Date Code orientation may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MMVL3102T1	SOD-323	3000 / Tape & Reel
MMVL3102T1G	SOD-323 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

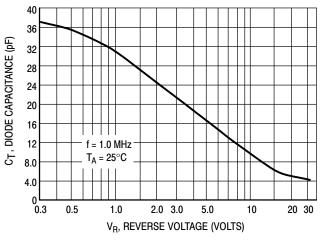
**Preferred** devices are recommended choices for future use and best overall value.

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage $(I_R = 10 \mu Adc)$	V <sub>(BR)R</sub>	30	_	-	Vdc
Reverse Voltage Leakage Current (V <sub>R</sub> = 25 Vdc, T <sub>A</sub> = 25°C)	I <sub>R</sub>	-	-	0.1	μAdc
Diode Capacitance Temperature Coefficient (V <sub>R</sub> = 4.0 Vdc, f = 1.0 MHz)	TC <sub>C</sub>	_	300	-	ppm/°C

	C <sub>t</sub> , Diode Capacitance V <sub>R</sub> = 3.0 Vdc, f = 1.0 MHz pF		Q, Figure of Merit V <sub>R</sub> = 3.0 Vdc f = 50 MHz	$C_R$ , Capacitance Ratio $C_3/C_{25}$ f = 1.0 MHz		
Device	Min	Nom	Max	Min	Min	Тур
MMVL3102T1	20	22	25	200	4.5	4.8

#### **TYPICAL CHARACTERISTICS**



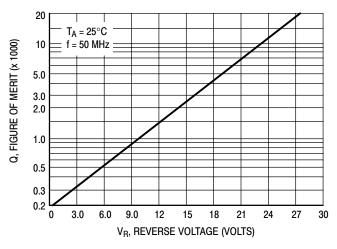
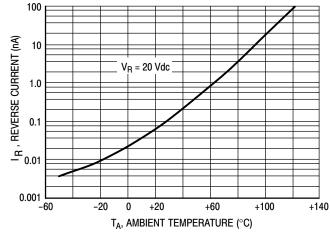


Figure 1. Diode Capacitance

Figure 2. Figure of Merit



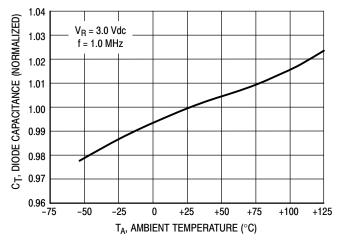


Figure 3. Leakage Current

Figure 4. Diode Capacitance

## NOTES ON TESTING AND SPECIFICATIONS

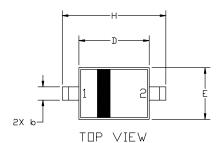
 $C_{R}$  is the ratio of  $C_{T}$  measured at 3.0 Vdc divided by  $C_{T}$  measured at 25 Vdc.





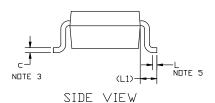
#### SOD-323 1.70x1.25x0.85 **CASE 477 ISSUE K**

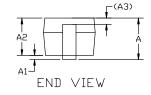
**DATE 11 MAR 2024** 



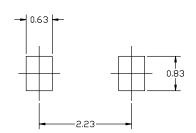
#### NOTES:

- 1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M, 2018.
- CONTROLLING DIMENSION: MILLIMETERS. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH 3. SOLDER PLATING.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
  DIMENSION L IS MEASURE FROM END OF RADIUS.





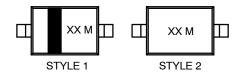
DIM	MI	LLIMETE	RS	
ויונע	MIN.	N□M.	MAX.	
Α	0.80	0.90	1.00	
A1	0.00	0.05	0.10	
A2	0.75	0.85	0.95	
А3	0.15 (REF)			
b	0.25	0.32	0.4	
C	0.09	0.12	0.18	
D	1.60	1.70	1.80	
Ε	1.15	1.25	1.35	
Н	2.30	2.50	2.70	
L	0.08			
L1	0.40 (REF)			



#### RECOMMENDED MOUNTING FOOTPRINT

\*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques
Reference manual, SDLDERRM/D.

#### **GENERIC MARKING DIAGRAM\***



XX = Specific Device Code M = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

STYLE 2: NO POLARITY PIN 1. CATHODE (POLARITY BAND) 2. ANODE

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DESCRIPTION:	SOD-323 1.70x1.25x0.85	•	PAGE 1 OF 1	

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